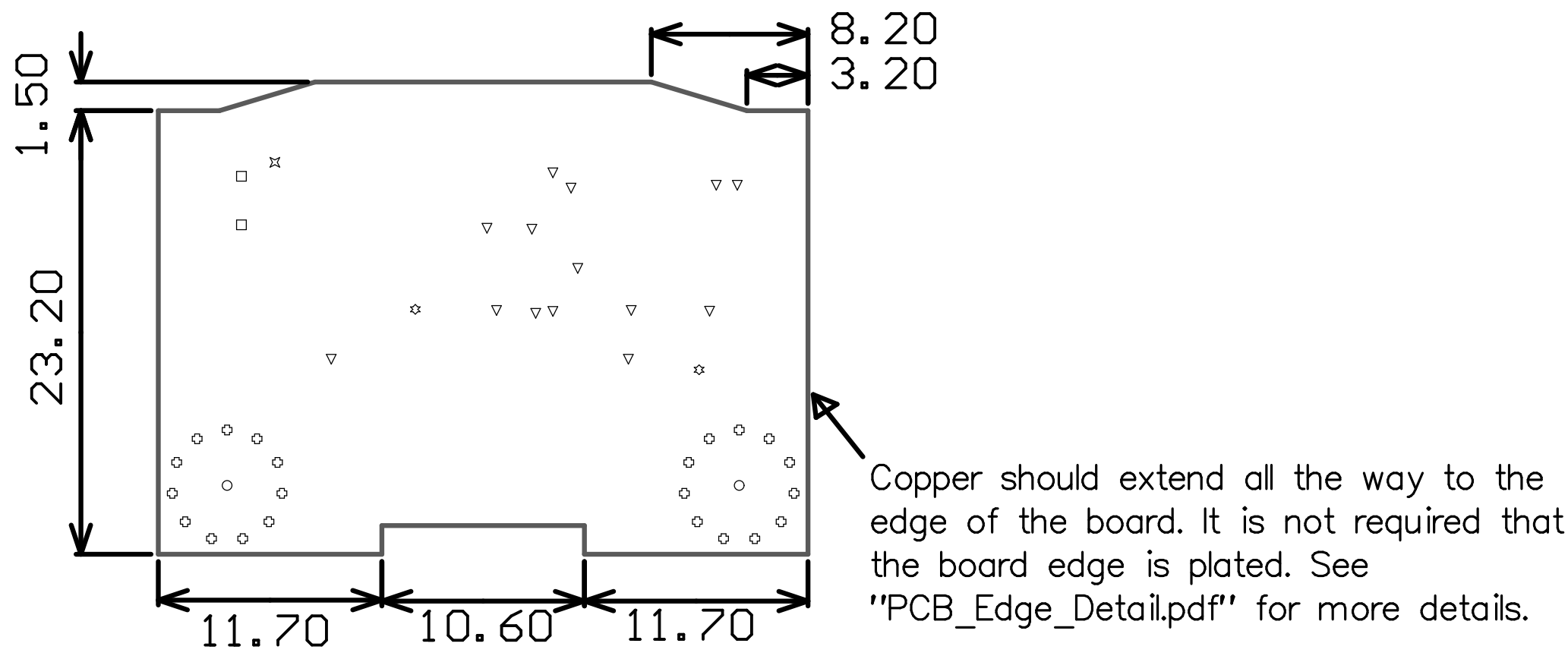


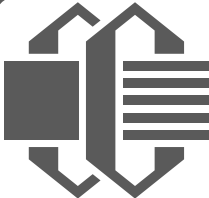
Symbol	Count	Hole Size	Plated	Drill Layer Pair	Pad Shape
▽	14	0.254mm <10.00mil>	PTH	Top Layer - Bottom Layer	Rounded
✱	2	0.381mm <15.00mil>	PTH	Top Layer - Bottom Layer	Rounded
⊗	22	0.400mm <15.75mil>	PTH	Top Layer - Bottom Layer	Rounded
✕	1	0.508mm <20.00mil>	PTH	Top Layer - Bottom Layer	Rounded
□	2	0.889mm <35.00mil>	PTH	Top Layer - Bottom Layer	Rounded
○	2	4.000mm <157.48mil>	PTH	Top Layer - Bottom Layer	Rounded
	43 Total				

LAYERS: 2
MATERIAL: FR4, RoHS, 94v0
THICKNESS: 1.6mm (~62 mils)
FINISH: Gold (ENIG) RoHS
SILK SCREEN: White
SOLDER MASK: GREEN

>> IMPORTANT FABRICATION NOTES <<

- 1) Many pads have intentional undersize solder mask openings/oversize pads for physical strength.
- 2) Make top and bottom solder masks exactly as shown. Do _NOT_ "open-up" the solder mask layers. This design uses "solder-mask-defined-pads".
- 3) Silkscreened Legend (white) must be clean and clear. Silkscreen legend must have good registration. Silkscreen may be intentionally placed over bare copper. Do not clip silkscreen to solder mask layer.





Crystalfontz
12412 East Saltese Avenue
Spokane Valley, WA 99216 USA
Tel: (509) 892-1200 <http://www.crystalfontz.com>
Copyright © 2019 Crystalfontz America, Inc.

PROJECT

CFA-10110

VERSION

h0v1

PCB

PCB10110

REVISION

h0v1

DATE

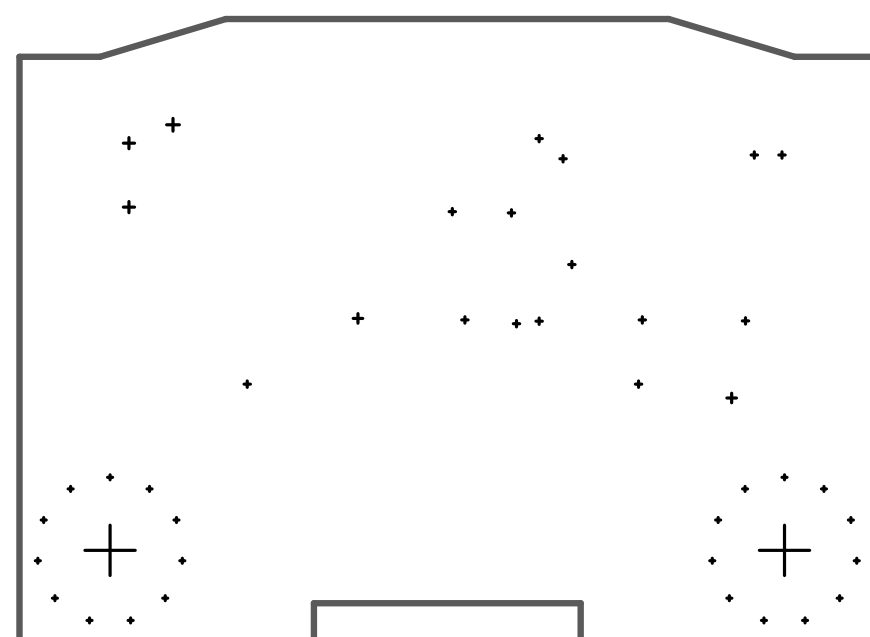
2020-12-17

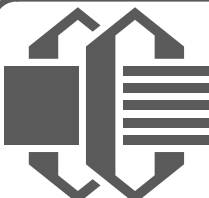
LAYER

Drill Drawing/Notes

FILE NAME

CFA10110_h0v1.GD1



 Crystalfontz 12412 East Saltese Avenue Spokane Valley, WA 99216 USA Tel: (509) 892-1200 http://www.crystalfontz.com Copyright © 2019 Crystalfontz America, Inc.	PROJECT CFA-10110		VERSION h0v1
	PCB PCB10110	REVISION h0v1	DATE 2020-12-17
	LAYER Drill Guide		FILE NAME CFA10110_h0v1.GG1